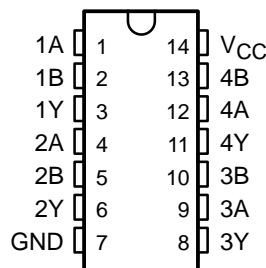


# CD54AC00, CD74AC00 QUADRUPLE 2-INPUT POSITIVE-NAND GATES

SCHS303C – JANUARY 2001 – REVISED JUNE 2002

- AC Types Feature 1.5-V to 5.5-V Operation and Balanced Noise Immunity at 30% of the Supply Voltage
- Speed of Bipolar F, AS, and S, With Significantly Reduced Power Consumption
- Balanced Propagation Delays
- $\pm 24$ -mA Output Drive Current  
– Fanout to 15 F Devices
- SCR-Latchup-Resistant CMOS Process and Circuit Design
- Exceeds 2-kV ESD Protection Per MIL-STD-883, Method 3015

CD54AC00 . . . F PACKAGE  
CD74AC00 . . . E OR M PACKAGE  
(TOP VIEW)



## description

The 'AC00 devices contain four independent 2-input NAND gates. Each gate performs the Boolean function of  $Y = \overline{A \cdot B}$  or  $Y = \overline{A} + \overline{B}$  in positive logic.

## ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–55°C to 125°C	PDIP – E	Tube	CD74AC00E	CD74AC00E
	SOIC – M	Tube	CD74AC00M	AC00M
		Tape and reel	CD74AC00M96	
	CDIP – F	Tube	CD54AC00F3A	CD54AC00F3A

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

## FUNCTION TABLE (each gate)

INPUTS		OUTPUT
A	B	Y
H	H	L
L	X	H
X	L	H

## logic diagram, each gate (positive logic)



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

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# CD54AC00, CD74AC00 QUADRUPLE 2-INPUT POSITIVE-NAND GATES

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## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$ .....	-0.5 V to 6 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see Note 1) .....	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) (see Note 1) .....	$\pm 50$ mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....	$\pm 50$ mA
Continuous current through $V_{CC}$ or GND .....	$\pm 100$ mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): E package .....	80°C/W
M package .....	86°C/W
Storage temperature range, $T_{stg}$ .....	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

## recommended operating conditions (see Note 3)

		$T_A = 25^\circ\text{C}$		$-40^\circ\text{C TO } 85^\circ\text{C}$		$-55^\circ\text{C TO } 125^\circ\text{C}$		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
$V_{CC}$	Supply voltage	1.5	5.5	1.5	5.5	1.5	5.5	V
$V_{IH}$	High-level input voltage	$V_{CC} = 1.5\text{ V}$		1.2		1.2		V
		$V_{CC} = 3\text{ V}$		2.1		2.1		
		$V_{CC} = 4.5\text{ V}$		3.15		3.15		
		$V_{CC} = 5.5\text{ V}$		3.85		3.85		
$V_{IL}$	Low-level input voltage	$V_{CC} = 1.5\text{ V}$		0.3		0.3		V
		$V_{CC} = 3\text{ V}$		0.9		0.9		
		$V_{CC} = 4.5\text{ V}$		1.35		1.35		
		$V_{CC} = 5.5\text{ V}$		1.65		1.65		
$V_I$	Input voltage	0	$V_{CC}$	0	$V_{CC}$	0	$V_{CC}$	V
$V_O$	Output voltage	0	$V_{CC}$	0	$V_{CC}$	0	$V_{CC}$	V
$I_{OH}$	High-level output current	$V_{CC} = 4.5\text{ V to } 5.5\text{ V}$		-24	-24	-24	-24	mA
$I_{OL}$	Low-level output current	$V_{CC} = 4.5\text{ V to } 5.5\text{ V}$		24	24	24	24	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	$V_{CC} = 1.5\text{ V to } 3\text{ V}$		50	50	50	50	ns/V
		$V_{CC} = 3.6\text{ V to } 5.5\text{ V}$		20	20	20	20	

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



# CD54AC00, CD74AC00 QUADRUPLE 2-INPUT POSITIVE-NAND GATES

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**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C		–40°C TO 85°C		–55°C TO 125°C		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
V <sub>OH</sub>	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = –50 μA	1.5 V	1.4	1.4	1.4			V
			3 V	2.9	2.9	2.9			
			4.5 V	4.4	4.4	4.4			
		I <sub>OH</sub> = –4 mA	3 V	2.58	2.48	2.4			
		I <sub>OH</sub> = –24 mA	4.5 V	3.94	3.8	3.7			
		I <sub>OH</sub> = –50 mA†	5.5 V			3.85			
V <sub>OL</sub>	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	1.5 V	0.1	0.1	0.1		V	
			3 V	0.1	0.1	0.1			
			4.5 V	0.1	0.1	0.1			
		I <sub>OL</sub> = 12 mA	3 V	0.36	0.44	0.5			
		I <sub>OL</sub> = 24 mA	4.5 V	0.36	0.44	0.5			
		I <sub>OL</sub> = 50 mA†	5.5 V			1.65			
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V		±0.1	±1	±1	μA		
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or GND, I <sub>O</sub> = 0	5.5 V		4	40	80	μA		
C <sub>i</sub>				10	10	10	pF		

† Test one output at a time, not exceeding 1-second duration. Measurement is made by forcing indicated current and measuring voltage to minimize power dissipation. Test verifies a minimum 50-Ω transmission-line drive capability at 85°C and 75-Ω transmission-line drive capability at 125°C.

**switching characteristics over recommended operating free-air temperature range, V<sub>CC</sub> = 1.5 V, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	–40°C TO 85°C		–55°C TO 125°C		UNIT
			MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A or B	Y		83		91	ns
t <sub>PHL</sub>				83		91	

**switching characteristics over recommended operating free-air temperature range, V<sub>CC</sub> = 3.3 V ± 0.3 V, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	–40°C TO 85°C		–55°C TO 125°C		UNIT
			MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A or B	Y	2.7	9.3	2.6	10.2	ns
t <sub>PHL</sub>			2.7	9.3	2.6	10.2	



**CD54AC00, CD74AC00  
QUADRUPLE 2-INPUT POSITIVE-NAND GATES**

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**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 5 V ± 0.5 V, C<sub>L</sub> = 50 pF (unless otherwise noted) (see Figure 1)**

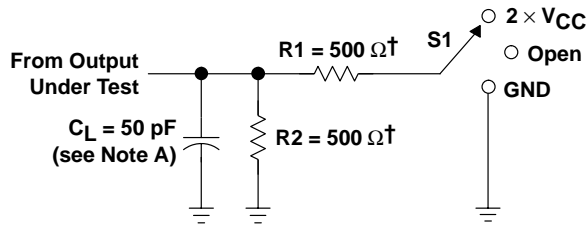
PARAMETER	FROM (INPUT)	TO (OUTPUT)	-40°C TO 85°C		-55°C TO 125°C		UNIT
			MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A or B	Y	1.9	6.6	1.8	7.3	ns
t <sub>PHL</sub>			1.9	6.6	1.8	7.3	

**operating characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C**

PARAMETER	TYP	UNIT
C <sub>pd</sub> Power dissipation capacitance	45	pF



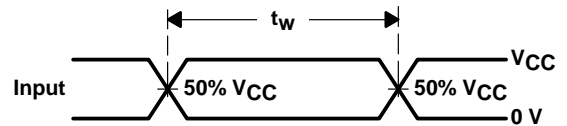
PARAMETER MEASUREMENT INFORMATION



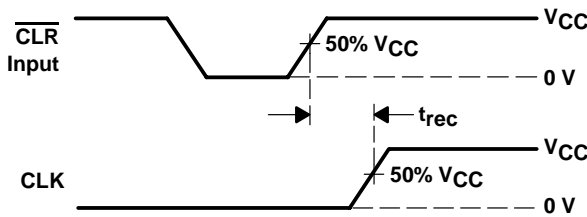
† When  $V_{CC} = 1.5\text{ V}$ ,  $R_1 = R_2 = 1\text{ k}\Omega$

LOAD CIRCUIT

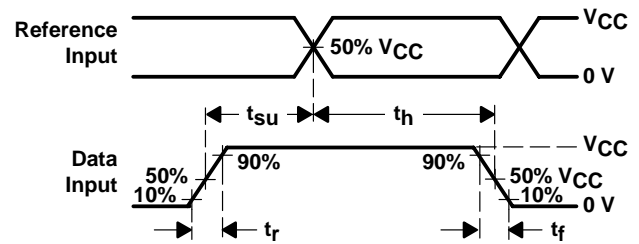
TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	$2 \times V_{CC}$
$t_{PHZ}/t_{PZH}$	GND



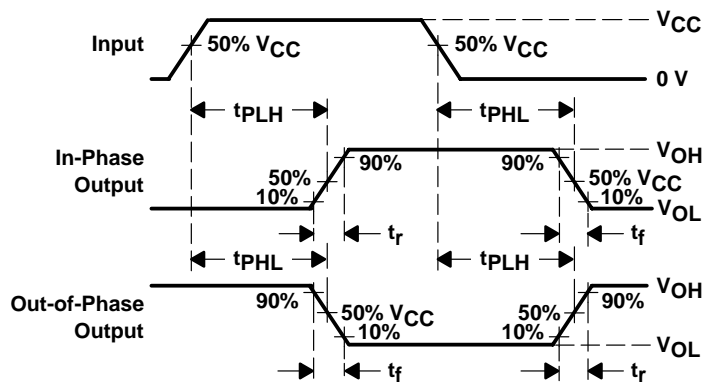
VOLTAGE WAVEFORMS  
 PULSE DURATION



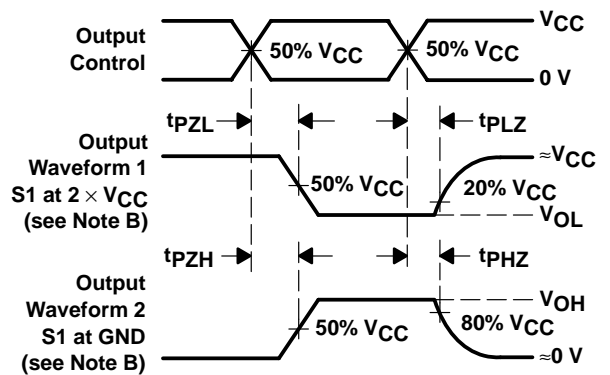
VOLTAGE WAVEFORMS  
 RECOVERY TIME



VOLTAGE WAVEFORMS  
 SETUP AND HOLD AND INPUT RISE AND FALL TIMES



VOLTAGE WAVEFORMS  
 PROPAGATION DELAY AND OUTPUT TRANSITION TIMES



VOLTAGE WAVEFORMS  
 OUTPUT ENABLE AND DISABLE TIMES

- NOTES: A.  $C_L$  includes probe and test-fixture capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{ MHz}$ ,  $Z_O = 50\ \Omega$ ,  $t_r = 3\text{ ns}$ ,  $t_f = 3\text{ ns}$ . Phase relationships between waveforms are arbitrary.  
 D. For clock inputs,  $f_{max}$  is measured with the input duty cycle at 50%.  
 E. The outputs are measured one at a time with one input transition per measurement.  
 F.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .  
 G.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .  
 H.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CD54AC00F3A	ACTIVE	CDIP	J	14	1	None	Call TI	Level-NC-NC-NC
CD74AC00E	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD74AC00M	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD74AC00M96	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**None:** Not yet available Lead (Pb-Free).

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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